



## Description

The IRFB4410ZPBF uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

## General Features

$V_{DS} = 100V$   $I_D = 70A$

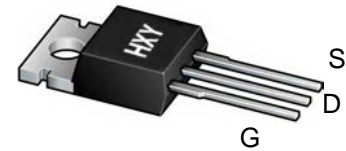
$R_{DS(ON)} < 10.5m\Omega @ V_{GS}=10V$

## Application

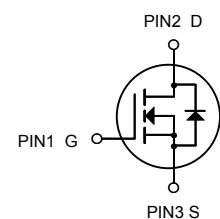
Battery protection

Load switch

Uninterruptible power supply



TO-220  
(TO-220AB)



N-Channel MOSFET

## Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
IRFB4410ZPBF	TO-220(TO-220AB)	FB4410Z XXXX	50

## Absolute Maximum Ratings ( $T_C=25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current $T_C=25^{\circ}C$	70	A
$I_{DM}$	Puled Drain Current note1	280	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	110	mJ
$P_D@T_C=25^{\circ}C$	Total Power Dissipation <sup>4</sup>	100	W
$T_{STG}$	Storage Temperature Range	-55 to 150	$^{\circ}C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^{\circ}C$
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>	64	$^{\circ}C/W$
$R_{\theta JC}$	Thermal Resistance Junction-Ambient <sup>1</sup>	1.25	$^{\circ}C/W$



**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V$ , $I_D=250\mu A$	100	---	---	V
$\frac{\partial BV_{DSS}}{\partial T_J}$	BVDSS Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_D=1mA$	---	0.098	---	$V/^\circ\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance <sup>2</sup>	$V_{GS}=10V$ , $I_D=20A$	---	8.5	10.5	$m\Omega$
		$V_{GS}=4.5V$ , $I_D=15A$	---	9.5	15	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250\mu A$	1.0	---	2.5	V
$\frac{\partial V_{GS(th)}}{\partial T_J}$	$V_{GS(th)}$ Temperature Coefficient		---	-4.57	---	$mV/^\circ\text{C}$
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=80V$ , $V_{GS}=0V$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu A$
		$V_{DS}=80V$ , $V_{GS}=0V$ , $T_J=55^\circ\text{C}$	---	---	5	
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}=0V$	---	---	$\pm 100$	nA
$R_g$	Gate Resistance	$V_{DS}=0V$ , $V_{GS}=0V$ , $f=1MHz$	---	0.48	---	$\Omega$
$Q_g$	Total Gate Charge (10V)	$V_{DS}=50V$ , $V_{GS}=50V$ , $I_D=10A$	---	31.3	---	nC
$Q_{gs}$	Gate-Source Charge		---	3.49	---	
$Q_{gd}$	Gate-Drain Charge		---	7.63	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=50V$ , $V_{GS}=10V$ , $R_G=4\Omega$ , $I_D=10A$	---	16	---	ns
$T_r$	Rise Time		---	10	---	
$T_{d(off)}$	Turn-Off Delay Time		---	40	---	
$T_f$	Fall Time		---	6	---	
$C_{iss}$	Input Capacitance	$V_{DS}=50V$ , $V_{GS}=0V$ , $f=1MHz$	---	1368	---	pF
$C_{oss}$	Output Capacitance		---	451	---	
$C_{rss}$	Reverse Transfer Capacitance		---	12.9	---	
$I_S$	Continuous Source Current <sup>1,5</sup>	$V_G=V_D=0V$ , Force Current	---	---	70	A
$I_{SM}$	Pulsed Source Current <sup>2,5</sup>		---	---	280	A
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	$V_{GS}=0V$ , $I_S=1A$ , $T_J=25^\circ\text{C}$	---	---	1.2	V
$t_{rr}$	Reverse Recovery Time	$I_F=10A$ , $dI/dt=100A/\mu s$ , $T_J=25^\circ\text{C}$	---	103	---	nS
$Q_{rr}$	Reverse Recovery Charge		---	187	---	nC

Note :

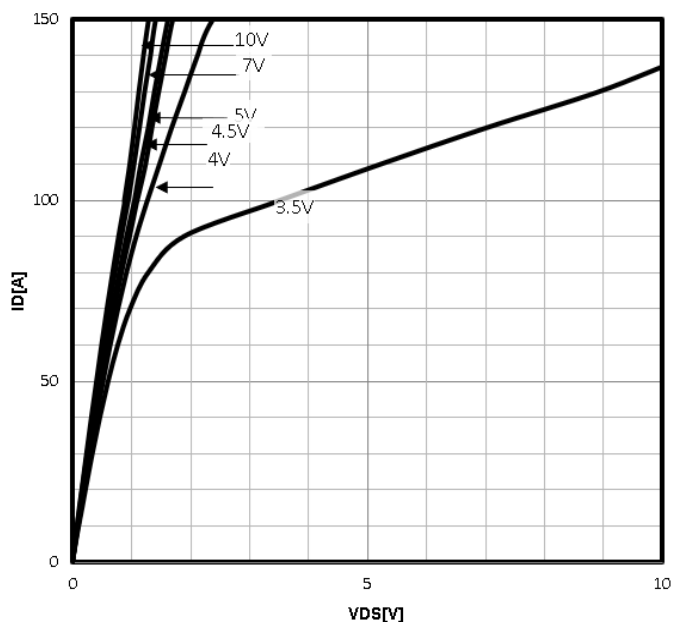
- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is  $V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=11A$
- 4.The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
- 5 .The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation.



## Typical Characteristics

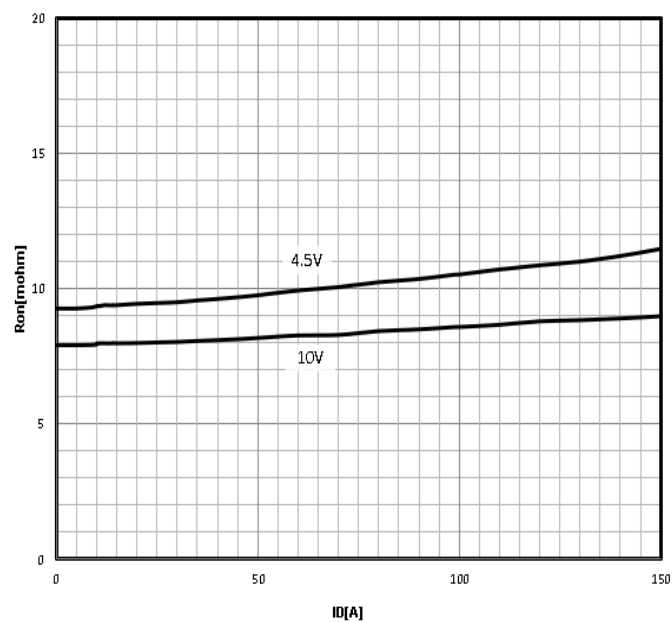
Typ. output characteristics

$$I_D = f(V_{DS})$$



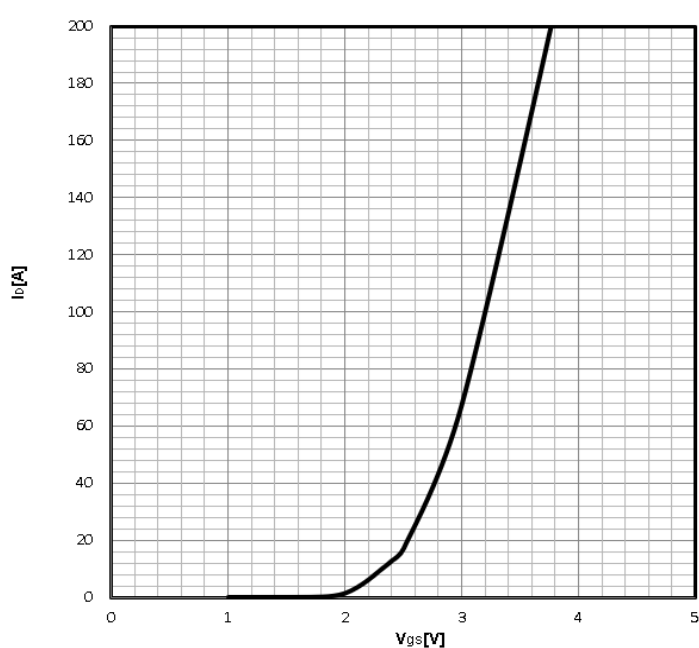
Typ. drain-source on resistance

$$R_{DS(on)} = f(I_D)$$



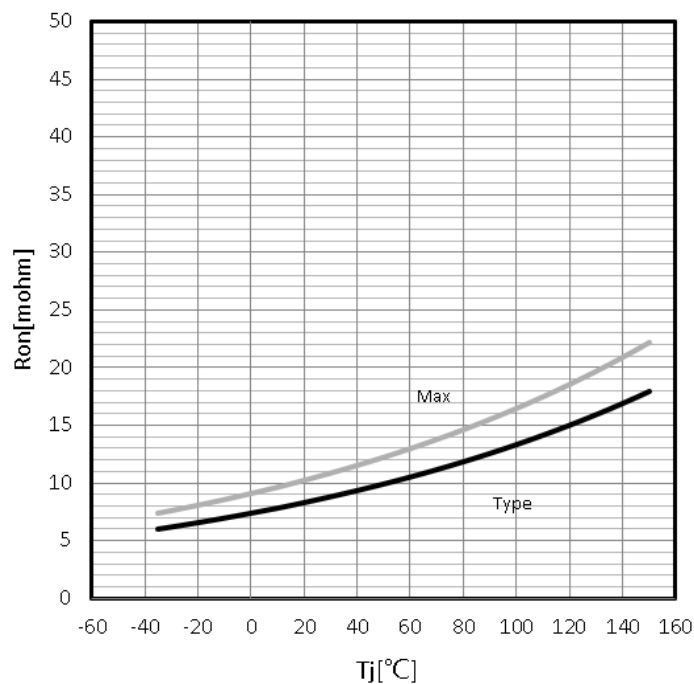
Typ. transfer characteristics

$$I_D = f(V_{GS})$$



Drain-source on-state resistance

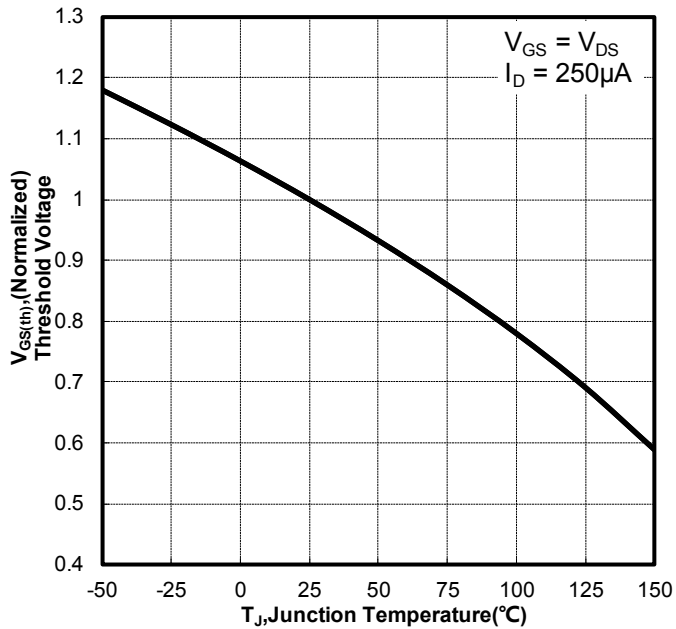
$$R_{DS(on)} = f(T_j); I_D = 20A; V_{GS} = 10V$$





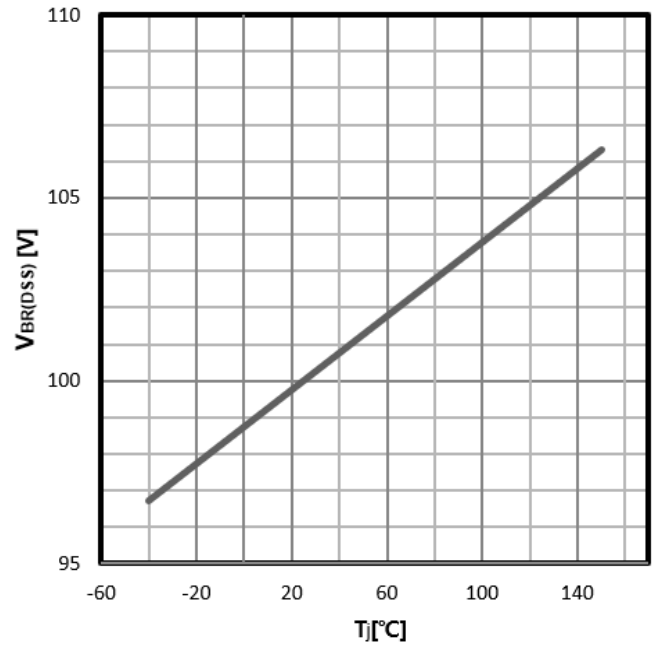
### Gate Threshold Voltage

$$V_{TH}=f(T_j); I_D=250\mu A$$



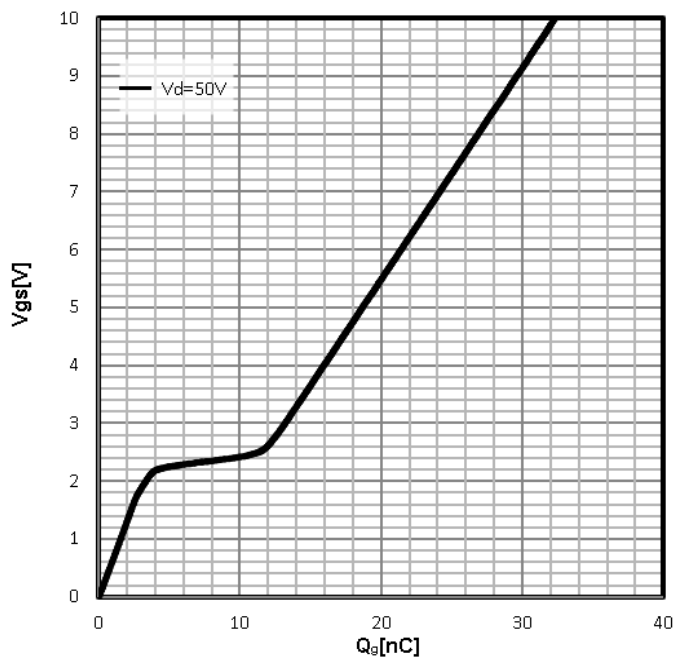
### Drain-source breakdown voltage

$$V_{BR(DSS)}=f(T_j); I_D=250\mu A$$



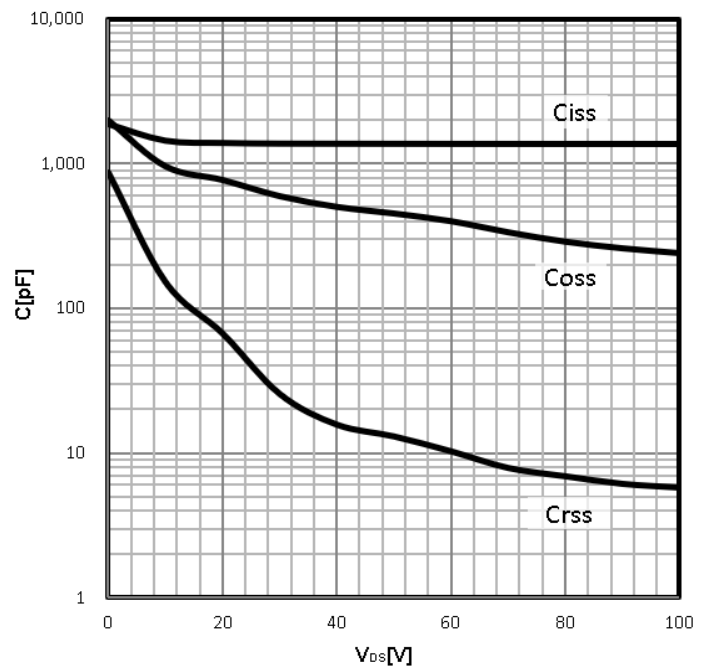
### Typ. gate charge

$$V_{GS}=f(Q_g); I_D=10A$$



### Typ. capacitances

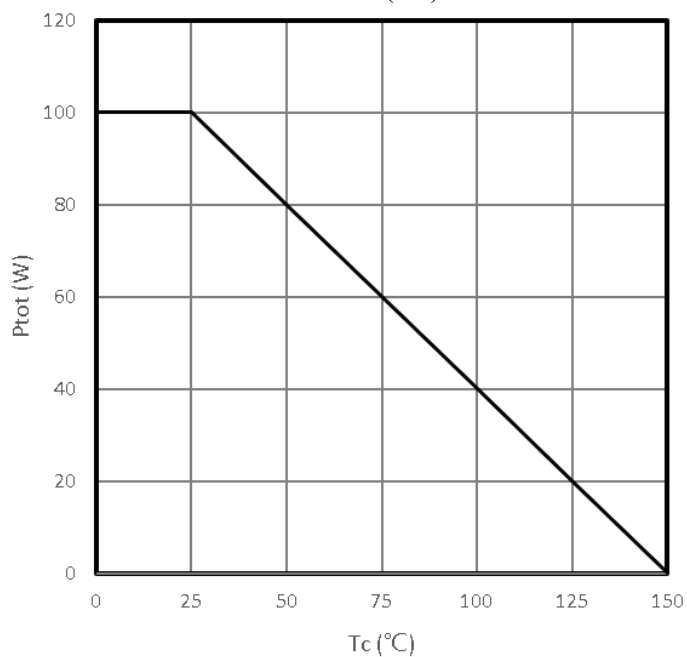
$$C=f(V_{DS}); V_{GS}=0V; f=1MHz$$





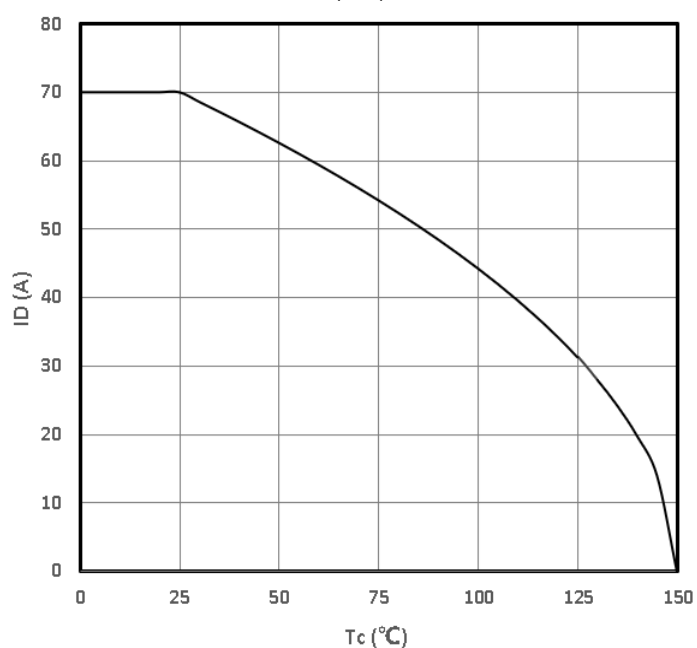
**Power Dissipation**

$$P_{\text{tot}}=f(T_C)$$



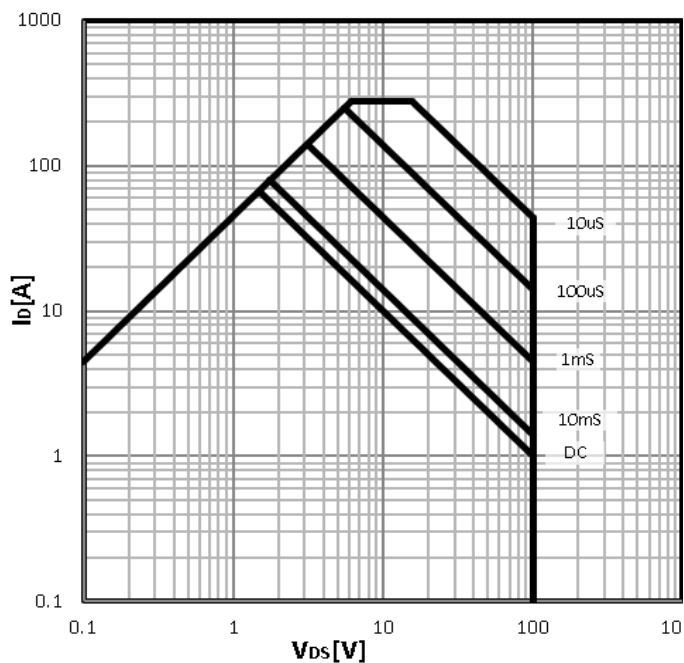
**Maximum Drain Current**

$$I_D=f(T_C)$$



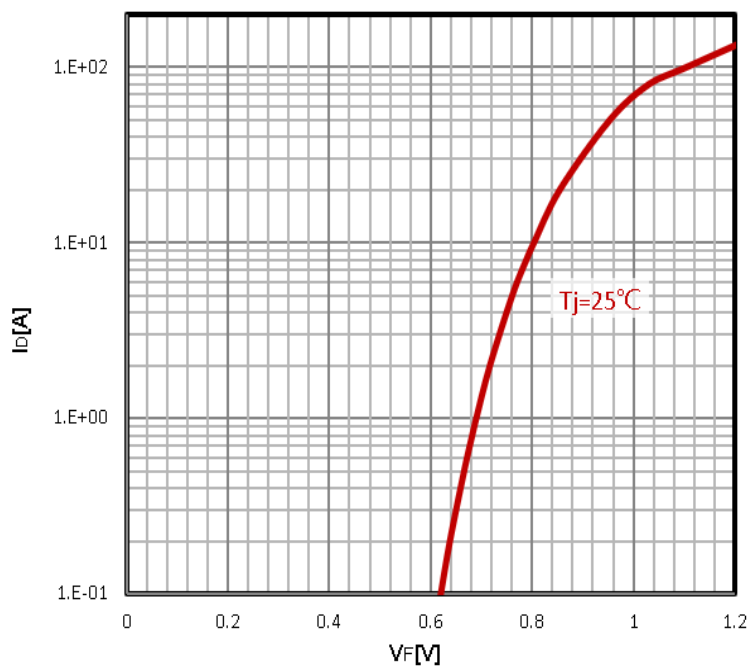
**Safe operating area**

$$I_D=f(V_{DS})$$



**Body Diode Forward Voltage Variation**

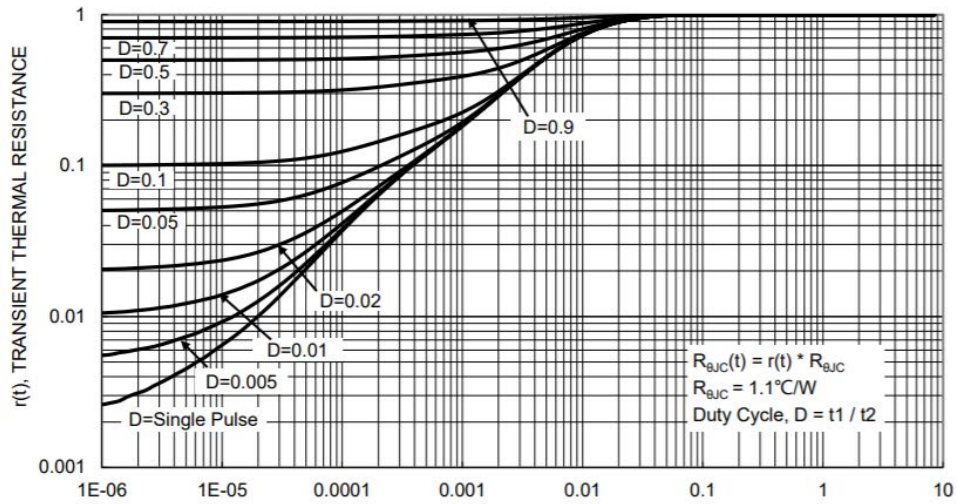
$$I_F=f(V_{GS})$$

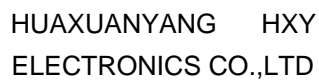




### Max. transient thermal impedance

$$Z_{thJC} = f(t_p)$$







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